

	Type	Hits	Search Text	DBs	Time Stamp
1	BRS	2893	438/612	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:12
2	BRS	3223	438/637	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:13
3	BRS	760	438/640	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:13
4	BRS	1703	438/710	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:14
5	BRS	856	438/712	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:14
6	BRS	525	438/713	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:15
7	BRS	989	438/738	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:20
8	BRS	3532	438/622	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:21
9	BRS	4020	438/624	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 15:23
10	BRS	105933	silicon adj oxide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:01
11	BRS	114014	silicon adj nitride	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:01
12	BRS	4397259	aperture or opening or hole	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:02
13	BRS	486790	taper\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:02
14	BRS	503669	pad or bondpad	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:02
15	BRS	491433	etch\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:03
16	BRS	34655	(silicon adj oxide) same (silicon adj nitride)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:03

	Type	Hits	Search Text	DBs	Time Stamp
17	BRS	7845	(aperture or opening or hole) same ((silicon adj oxide) same (silicon adj nitride))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:03
18	BRS	124	taper\$ same ((aperture or opening or hole) same ((silicon adj oxide) same (silicon adj nitride)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:09
19	BRS	2894	438/612	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:09
20	BRS	3539	438/622	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:09
21	BRS	4021	438/624	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:09
22	BRS	3229	438/637	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:10
23	BRS	760	438/640	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:10